

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:	Takeshi Honda, et al.	Examiner:	Unassigned
Serial No.:	Unassigned	Art Unit:	Unassigned
Filed:	Herewith	Docket:	19002
For:	SEMICONDUCTOR STORAGE APPARATUS	Dated:	July 6, 2005

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

Sir:

In accordance with 37 C.F.R. §§ 1.97 and 1.98, it is requested that the following references, which are also listed on the attached Form PTO-1449, be made of record in the above-identified case.

1. Japanese Laid-Open Patent Application No. 2001-195878, dated July 19, 2001, together with an English language Abstract;
2. Japanese Laid-Open Patent Application No. 2001-325791, dated November 11, 2001, together with an English language Abstract; and

CERTIFICATE OF MAILING BY "EXPRESS MAIL"

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I hereby certify that this correspondence is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 C.F.R. § 1.10 on the date indicated above and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on July 6, 2005

Dated: July 6, 2005

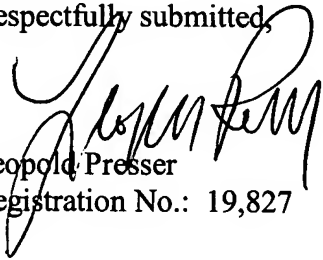

Leopold Presser

3. Japanese Laid-Open Patent Application No. 2002-008367, dated January 11, 2002, together with an English language Abstract;
4. Japanese Laid-Open Patent Application No. 2002-074974, dated March 15, 2002, together with an English language Abstract;
5. Japanese Laid-Open Patent Application No. 2002-170374, dated June 14, 2002, together with an English language Abstract;
6. Japanese Laid-Open Patent Application No. 2002-170375, dated June 14, 2002, together with an English language Abstract;
7. Japanese Laid-Open Patent Application No. 2002-170376, dated June 14, 2002, together with an English language Abstract;
8. Japanese Laid-Open Patent Application No. 2002-197852, dated July 12, 2002, together with an English language Abstract;
9. Japanese Laid-Open Patent Application No. 2003-257175, dated September 12, 2003, together with an English language Abstract;
10. Japanese Laid-Open Patent Application No. 10-106255, dated April 24, 1998, together with an English language Abstract;
11. Japanese Laid-Open Patent Application No. 2002-093144, dated March 29, 2002, together with an English language Abstract; and
12. Japanese Laid-Open Patent Application No. 2003-123464, dated April 25, 2003, together with an English language Abstract.

Reference Nos. 1 – 9 are described in the Specification. Reference Nos. 10-12 were cited in the International Search Report of a corresponding International PCT Application. Applicants are submitting copies of the above-cited references, together with a copy of the Search Report.

Inasmuch as this Information Disclosure Statement is being submitted in accordance with the schedule set out in 37 C.F.R. § 1.97(b), no statement or fee is required.

Respectfully submitted,



Leopold Presser
Registration No.: 19,827

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LP:ej

INFORMATION DISCLOSURE CITATION
(Use several sheets if necessary)

ATTY DOCKET NO.

19002

APPLICATION NO.

107541645
Unassigned

APPLICANT(S)

Takeshi Honda, et al.

FILING DATE

Herewith

GROUP ART UNIT

Unassigned

U.S. PATENT DOCUMENTS

*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE

U.S. PATENT APPLICATION PUBLICATIONS

*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
		2001-195878	7/19/01	Japan			✓	
		2001-325791	11/11/01	Japan			✓	
		2002-008367	1/11/02	Japan			✓	
		2002-074974	3/15/02	Japan			✓	
		2002-170374	6/14/02	Japan			✓	

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

EXAMINER	DATE CONSIDERED
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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

INFORMATION DISCLOSURE CITATION <i>(Use several sheets if necessary)</i>	ATTY DOCKET NO. 19002		APPLICATION NO. 107541645 Unassigned
	Takeshi Honda, et al.		
	FILING Herewith	GROUP ART Unassigned	

U.S. PATENT DOCUMENTS

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U.S. PATENT APPLICATION PUBLICATIONS

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		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
		2002-170375	6/14/02	Japan			✓	
		2002-170376	6/14/02	Japan			✓	
		2002-197852	7/12/02	Japan			✓	
		2003-257175	9/12/03	Japan			✓	
		10-106255	4/24/98	Japan			✓	

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19002

APPLICATION NO.
107341645
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							YES	NO
		2002-093144	3/29/02	Japan			✓	
		2003-123464	4/25/03	Japan			✓	

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